

BONDING OF PARTS WITH DISSIMILAR THERMAL EXPANSION COEFFICIENTS

Inventor: Kaspar Tobias Winther, citizen of Denmark
7 Walnut Street, Upton, MA 05168-1101
508-529-0093

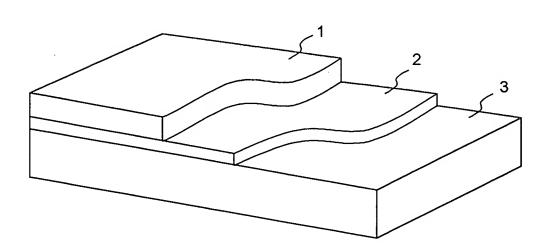


Fig. 1. Partial cut away view of the bonding structure.

- Item 1: One of the materials to be bonded. Only a section of the material is shown.
- Item 2: The intermediate layer that possesses a gradual change in the thermal expansion coefficient from one side of the layer to the other side. Only part of this layer is shown.
- Item 3: The other material to be bonded.